AMPMODU | AMPMODU Headers

TE Internal #: 6-102692-3

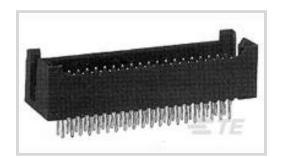
PCB Mount Header, Vertical, Board-to-Board, 40 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 40
Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	40
Number of Rows	2
Board-to-Board Configuration	Parallel

Electrical Characteristics

Termination Resistance	12 mΩ
Dielectric Withstanding Voltage (Max)	750 VACrms
Operating Voltage	250 VAC

Body Features

Contact Features

Contact Mating Area Length	5.08 mm[.2 in]



Mating Square Post Dimension	.64 mm[.025 in]
	100 – 200 μin
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Type	Pin
Contact Current Rating (Max)	2 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	4.57 mm[.18 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Retention	Without
PCB Mount Retention Type	Board Retention Tail
Mating Alignment	With
Mating Alignment Type	Guide Pins
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
	Board Mount
Housing Features	Dodra Modrit
Housing Features Centerline (Pitch)	2.54 mm[.1 in]
Centerline (Pitch)	2.54 mm[.1 in]
Centerline (Pitch) Housing Material	2.54 mm[.1 in]
Centerline (Pitch) Housing Material Dimensions	2.54 mm[.1 in] Thermoplastic
Centerline (Pitch) Housing Material Dimensions Connector Height	2.54 mm[.1 in] Thermoplastic 13.97 mm[.55 in]
Centerline (Pitch) Housing Material Dimensions Connector Height Row-to-Row Spacing	2.54 mm[.1 in] Thermoplastic 13.97 mm[.55 in] 2.54 mm[.1 in]
Centerline (Pitch) Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height	2.54 mm[.1 in] Thermoplastic 13.97 mm[.55 in] 2.54 mm[.1 in] 11.43 mm[.45 in]
Centerline (Pitch) Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height PCB Thickness (Recommended)	2.54 mm[.1 in] Thermoplastic 13.97 mm[.55 in] 2.54 mm[.1 in] 11.43 mm[.45 in]
Centerline (Pitch) Housing Material Dimensions Connector Height Row-to-Row Spacing Stack Height PCB Thickness (Recommended) Usage Conditions	2.54 mm[.1 in] Thermoplastic 13.97 mm[.55 in] 2.54 mm[.1 in] 11.43 mm[.45 in] 1.4 mm[.055 in]



Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
Approved Standards	CSA LE7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	32
Packaging Type	Tube

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Pin-in-Paste capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts









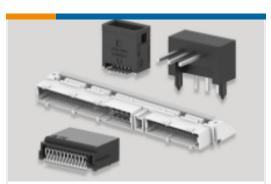
Also in the Series | AMPMODU Headers



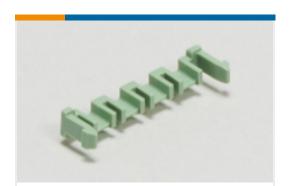
PCB Connector Mounting(1)



PCB Connector Shrouds(1)



PCB Headers & Receptacles(4875)



PCB Latches, Locks & Retainers(1)



Wire-to-Board Connector Assemblies & Housings(5)



Wire-to-Board Connector Contacts(65)

Customers Also Bought



60AYT6C J0=F7477



TE Part #9-1879214-7 CPF 0402 3K74 0.1% 25PPM 1K RL









TE Part #1648111-1 221-0011-01100



TE Part #646502-2 2MM HM DUST PROTECTOR TYPE D



TE Part #5-330873-0 TWIN THREADED PCB RCPT





Documents

Product Drawings

40 MODII 2PC HDR DR SHRD, ROHS

English

CAD Files

Customer View Model

ENG_CVM_6-102692-3_L2.3d_stp.zip

English

Customer View Model

ENG_CVM_6-102692-3_L2.2d_dxf.zip

English

3D PDF

English

Customer View Model

ENG_CVM_6-102692-3_L2.3d_igs.zip

English

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Datasheets & Catalog Pages

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5_CONT

English